Field Stop Trench IGBT 650 V, 75 A

AFGHL75T65SQDT

Using the novel field stop 4th generation IGBT technology and the Stealth Diode technology, AFGHL75T65SQDT offers the optimum performance with both low conduction and switching losses for a high efficiency operation in various applications, especially totem pole bridgeless PFC and DCDC block as well.

Features

- AEC-Q101 Qualified
- Maximum Junction Temperature: $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(Sat)} = 1.6 V (Typ.) @ I_C = 75 A$
- 100% of the Parts are Tested for ILM (Note 2)
- Fast Switching
- Tight Parameter Distribution
- RoHS Compliant

Typical Applications

- Automotive HEV-EV Onboard Chargers
- Automotive HEV-EV DC-DC Converters
- Totem Pole Bridgeless PFC

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-to-Emitter Voltage	V _{CES}	650	V
Gate-to-Emitter Voltage Transient Gate-to-Emitter Voltage	V _{GES}	±20 ±30	V
$ \begin{array}{c} \mbox{Collector Current (Note 1)} & @\ T_C = 25^\circ C \\ & @\ T_C = 100^\circ C \end{array} $	Ι _C	80 75	A
Pulsed Collector Current (Note 2)	I _{LM}	300	А
Pulsed Collector Current (Note 3)	I _{CM}	300	А
Diode Forward Current	١ _F	80 75	A
Pulsed Diode Maximum Forward Current	I _{FM(2)}	300	А
$ \begin{array}{ll} \mbox{Maximum Power Dissipation} & @\ T_C = 25^\circ C \\ & @\ T_C = 100^\circ C \end{array} $	PD	375 188	W
Operating Junction / Storage Temperature Range	T _J , T _{STG}	–55 to +175	°C
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	ΤL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limit by bond wire

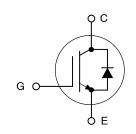
- 2. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 300 A, R_G = 17 Ω , Inductive Load
- 3. Repetitive Rating: pulse width limited by max. Junction temperature



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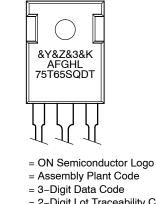
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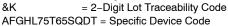
75 A, 650 V V_{CESat} = 1.6 V





MARKING DIAGRAM





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&Z

&З

ORDERING INFORMATION

Device	Package	Shipping
AFGHL75T65SQDT	TO-247-3L	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ extsf{ heta}JC}$	0.4	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ extsf{ heta}JC}$	0.65	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

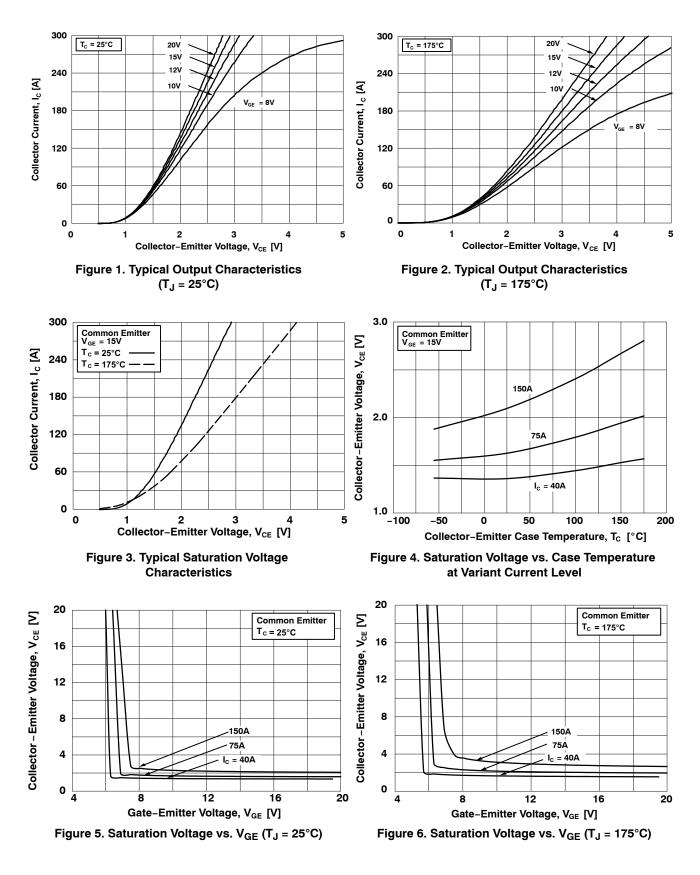
Parameter	Parameter Test Conditions		Min	Тур	Мах	Unit
OFF CHARACTERISTICS		-	-		-	-
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 V,$ $I_C = 1 mA$	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 V,$ $I_C = 1 mA$	$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	-	0.6	-	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	V _{GE} = 0 V, V _{CE} = 650 V	I _{CES}	_	-	250	μA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V},$ $V_{CE} = 0 \text{ V}$	I _{GES}	_	-	±400	nA
ON CHARACTERISTICS						
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 75$ mA	V _{GE(th)}	3.4	4.9	6.4	V
Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 75 A V _{GE} = 15 V, I _C = 75 A, T _J = 175°C	V _{CE(sat)}		1.6 1.95	2.1 -	V
DYNAMIC CHARACTERISTICS						
Input capacitance	$V_{CE} = 30 V,$	Cies	-	4617	-	pF
Output capacitance	V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	152	-	-
Reverse transfer capacitance		C _{res}	-	13	-	
Gate charge total	V _{CE} = 400 V,	Qg	-	136	-	nC
Gate-to-emitter charge	l _C = 75 A, V _{GE} = 15 V	Q _{ge}	-	25	-	
Gate-to-collector charge		Q _{gc}	-	32	-	
SWITCHING CHARACTERISTICS, INDUC						
Turn-on delay time	$T_{\rm C} = 25^{\circ}{\rm C},$	t _{d(on)}	-	21	-	ns
Rise time	V _{CC} = 400 V, I _C = 37.5 A,	t _r	-	16	-	1
Turn-off delay time	R _G = 4.7 Ω, V _{GE} = 15 V,	t _{d(off)}	-	113	-	1
Fall time	Inductive Load	t _f	-	8	-	1
Turn-on switching loss		E _{on}	-	0.77	-	mJ
Turn-off switching loss		E _{off}	-	0.23	-	-
Total switching loss		E _{ts}	-	1.0	-	
Turn-on delay time	$T_{\rm C} = 25^{\circ}{\rm C},$	t _{d(on)}	-	24	-	ns
Rise time	$V_{CC} = 400 \text{ V}, \\ I_{C} = 75 \text{ A}, \\ R_{G} = 4.7 \Omega, \\ V_{GE} = 15 \text{ V}, \\ Inductive Load$	t _r	-	44	-	1
Turn-off delay time		t _{d(off)}	-	106	-	1
Fall time		t _f	-	68	-	1
Turn-on switching loss		E _{on}	-	2.12	-	mJ
Turn–off switching loss		E _{off}	-	1.14	-	1
Total switching loss		E _{ts}	-	3.26	-	1

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

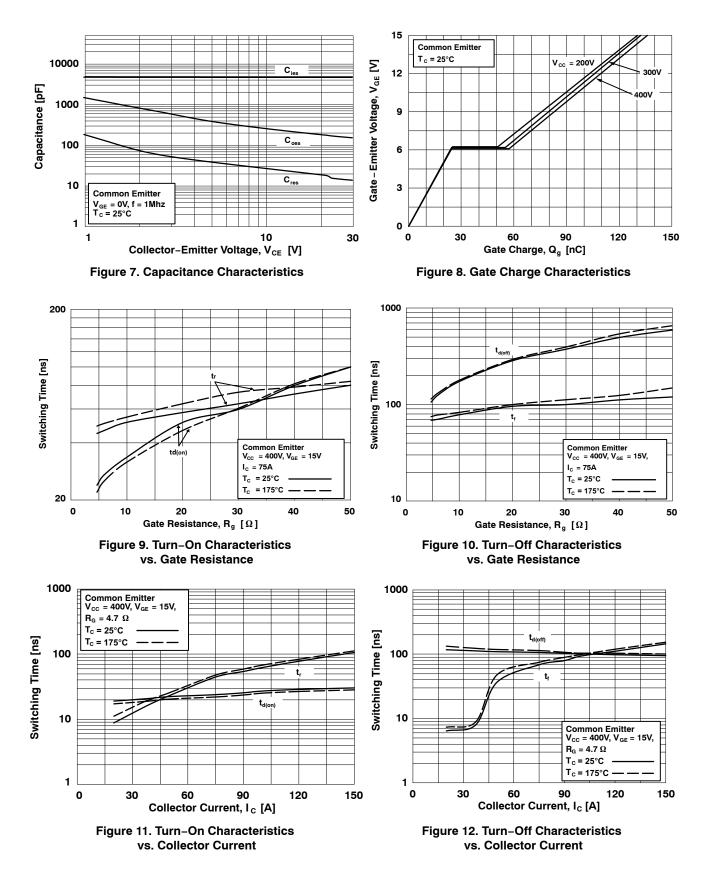
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS, IN	DUCTIVE LOAD	•		•		
Turn-on delay time	$T_{\rm C} = 175^{\circ}{\rm C},$	t _{d(on)}	-	20	_	ns
Rise time	V _{CC} = 400 V, I _C = 37.5 A,	t _r	-	19	-	
Turn-off delay time	R _G = 4.7 Ω, V _{GF} = 15 V,	t _{d(off)}	-	124	-	
Fall time	Inductive Load	t _f	-	7.7	-	
Turn-on switching loss		Eon	-	1.52	-	mJ
Turn-off switching loss		E _{off}	-	0.43	-	
Total switching loss		E _{ts}	-	1.95	-	
Turn-on delay time	$T_{\rm C} = 175^{\circ}{\rm C},$	t _{d(on)}	-	24	-	ns
Rise time	V _{CC} = 400 V, I _C = 75 A,	t _r	-	45	-	
Turn-off delay time	R _G = 4.7 Ω, V _{GE} = 15 V,	t _{d(off)}	-	114	_	
Fall time	Inductive Load	t _f	-	76	-	
Turn-on switching loss	1 – – – – – – – – – – – – – – – – – – –	Eon	-	3.32	-	mJ
Turn-off switching loss		E _{off}	-	1.42	-	
Total switching loss		E _{ts}	-	4.74	-	
DIODE CHARACTERISTICS						-
Diode Forward Voltage	I _F = 75 A, T _C = 25°C	V _{FM}	-	1.65	2.1	V
	I _F = 75 A, T _C = 175°C		-	1.55	-	
Reverse Recovery Energy	$I_F = 75 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A/s}, T_C = 175^{\circ}\text{C}$	E _{rec}	-	150	_	μJ
Diode Reverse Recovery Time	$I_F = 75 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A/s}, T_C = 25^{\circ}\text{C}$	T _{rr}	-	75	-	ns
	I _F = 75 A, dI _F /dt = 200 A/s, T _C = 175°C		-	328	_	
Diode Reverse Recovery Charge	$I_F = 75 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A/s}, T_C = 25^{\circ}\text{C}$	Q _{rr}	-	173	-	nC
	I _F = 75 A, dI _F /dt = 200 A/s, T _C = 175°C	1	-	2193	-	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

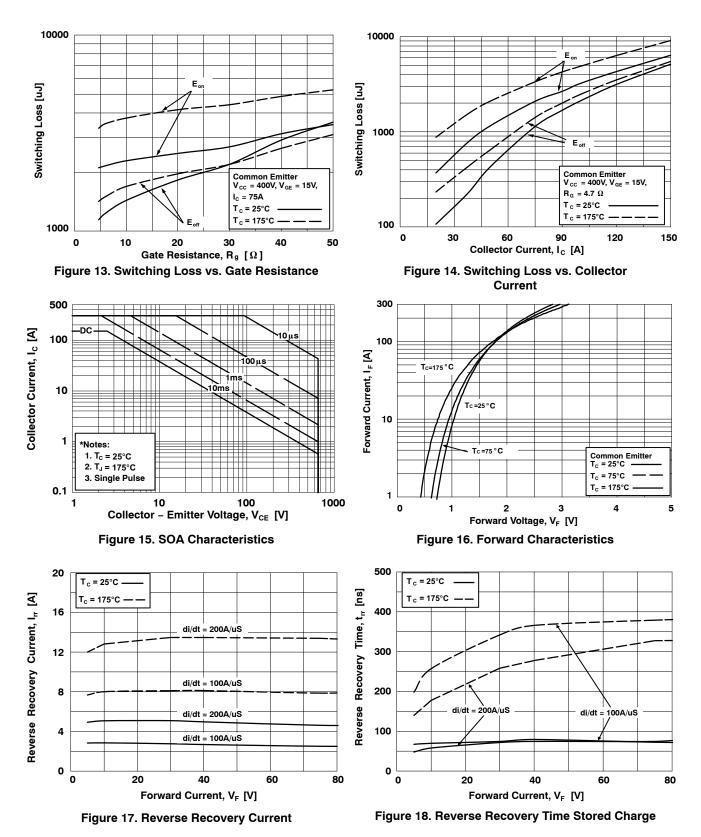
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

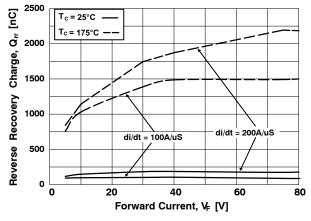


Figure 19. Stored Charge

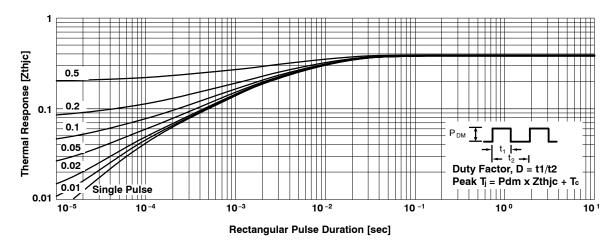


Figure 20. Transient Thermal Impedance of IGBT

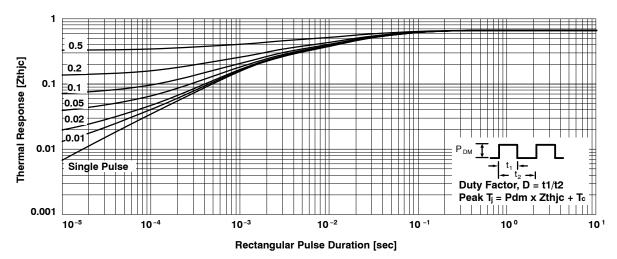
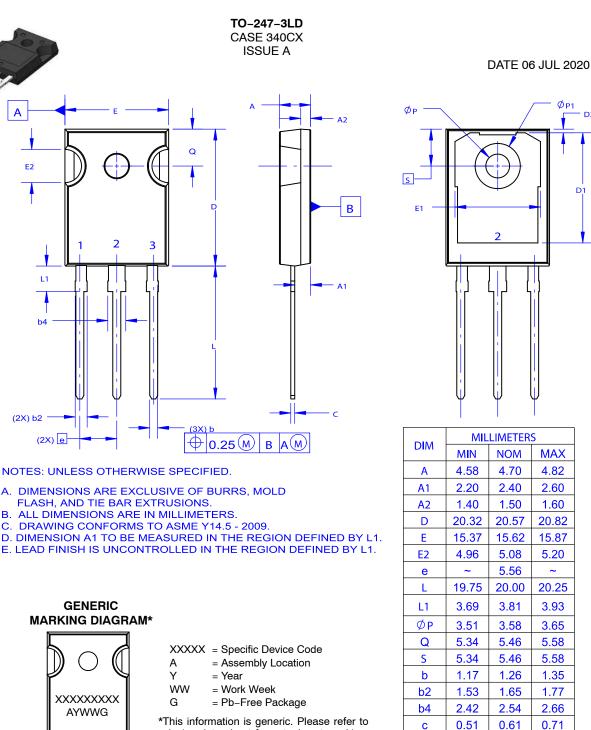


Figure 21. Transient Thermal Impedance of Diode



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

С

D1

D2

E1

Ø P1

13.08

0.51

12.81

6.60

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0.93

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6.80

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